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(71) Applicant (for all designated States except US): **IGNIS INNOVATION INC.** [CA/CA]; 22 Frederick Street, Suite 1025, Kitchener, Ontario N2H 6M6 (CA).

(72) Inventors; and

(75) Inventors/Applicants (for US only): **CHAJI, Gholam-reza** [CA/CA]; 463 Kelso Drive, Waterloo, Ontario N2V 2S3 (CA). **GUPTA, Vasudha** [IN/CA]; 60 Porter Crescent, Cambridge, Ontario N3C 0C1 (CA). **NATHAN, Arokia** [CA/GB]; 189 Huntingdon Road, Cambridge Cambridgeshire CB3 0DL (GB).

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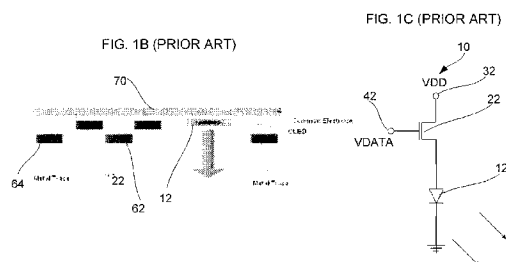
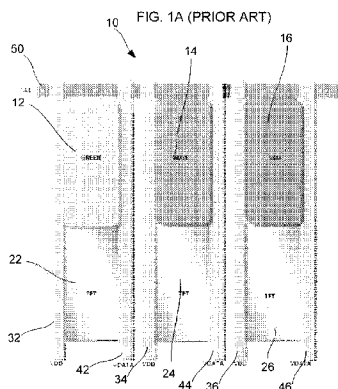
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(54) Title: HIGH RESOLUTION PIXEL ARCHITECTURE



(57) Abstract: A high resolution pixel using organic light emitting devices (OLEDs) in a staggered arrangement to increase aperture ratio is disclosed. The arrangement may be used with both bottom and top emission type pixels. The arrangement includes a first organic light emitting device emitting light of a first color. A second organic light emitting device emitting light of a second color is located in a bottom row under the first organic light emitting device. A third organic light emitting device emitting light of a third color is located in a top row with the first organic light emitting device.

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HIGH RESOLUTION PIXEL ARCHITECTURE

PRIORITY CLAIM

[0001] This application claims priority to Canadian Application No. 2,686,174, which was filed December 1, 2009.

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FIELD OF THE INVENTION

[0003] The present invention generally relates to active matrix organic light emitting device (AMOLED) displays, and particularly to a pixel structure that has a larger aperture ratio in such displays.

BACKGROUND

[0004] Currently, active matrix organic light emitting device ("AMOLED") displays are being introduced. The advantages of such displays include lower power consumption, manufacturing flexibility and faster refresh rate over conventional liquid crystal displays. In contrast to conventional liquid crystal displays, there is no backlighting in an AMOLED display as each pixel consists of different colored organic light emitting devices (e.g., red, green and blue) emitting light independently. The organic light emitting diodes (OLED) emit light based on current supplied through a drive transistor. The drive transistor is typically a thin film transistor (TFT) fabricated from either amorphous silicon or polysilicon. The power consumed in each OLED has a direct relation with the magnitude of the generated light in that OLED.

[0005] The drive-in current of the drive transistor determines the pixel's luminance and the surface (aperture) of the actual OLED device determines the pixel's OLED lifetime. AMOLED displays are typically fabricated from the OLED, the drive transistor, any other supporting circuits such as enable or select transistors as well as various other drive and

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programming lines. Such other components reduce the aperture of the pixel because they do not emit light but are needed for proper operation of the OLED.

[0006] Generally color displays have three OLEDs arranged in a “stripe” for each pixel 10 as shown in FIG. 1A. The pixel 10 in FIG. 1A is a bottom emission type OLED where the OLEDs are fabricated on the substrate of the integrated circuit where there is no other components such as transistors and metal lines. The pixel 10 includes OLEDs 12, 14 and 16 and corresponding drive transistors 22, 24 and 26 arranged in parallel creating a “stripe” arrangement. Parallel power lines 32, 34 and 36 are necessary to provide voltage to the OLEDs 12, 14 and 16 and drive transistors 22, 24 and 26. The OLEDs 12, 14 and 16 emit red, green and blue light respectively and different luminance levels for each OLED 12, 14 and 16 may be programmed to produce colors along the spectrum via programming voltages input from a series of parallel data lines 42, 44 and 46. As shown in FIG. 1A, additional area must be reserved for a select line 50 and the data lines 42, 44 and 46 as well as the power lines 32, 34 and 36 for the OLEDs 12, 14 and 16 and the drive transistors 22, 24 and 26. In this known configuration, the aperture of the integrated circuit of the pixel 10 is much less than the overall area of the integrated circuit because of the areas needed for the drive transistor and power and data lines. For example, in producing a shadow mask for fabricating such an integrated circuit for the pixel 10, the distance between two adjacent OLEDs such as the OLEDs 12 and 14 and the OLED size is significant (larger than 20 μm). As a result, for high resolution display (e.g. 253 ppi with 33.5 μm sub pixel width), the aperture ratio will be very low.

[0007] FIG. 1B shows a circuit diagram of the electronic components, namely the OLED 12, the drive transistor 22, the power input for the drive voltage line 32 and the programming voltage input 42 for each of the color OLEDs that make up the pixel 10. The programming voltage input 42 supplies variable voltage to the drive transistor 22 that in turn regulates the current to the OLED 12 to determine the luminance of the OLED 12.

[0008] FIG. 1C shows the cross section for the conventional bottom emission structure such as for the pixel 10 in FIG. 1A. As is shown, OLED 12 is fabricated to the side of the other components on the substrate in an open area. Thus, the OLED light emission area is limited by the other components in the pixel. A common electrode layer 70 provides electrical connection to the OLED 12. In this case, the current density is high because of the limited area for light

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emission. The OLED voltage is also high due to higher current density. As a result, the power consumption is higher and the OLED lifetime is reduced.

[0009] Another type of integrated circuit configuration for each of the OLEDs that make up the pixel involves fabricating the OLED over the backplane components (such as transistors and metal traces) and is termed a top emission configuration. The top emission configuration allows greater surface area for the OLED and hence a higher aperture ratio, but requires a thinner common electrode to the OLEDs because such an electrode must be transparent to allow light to be emitted from the OLEDs. The thin electrode results in higher resistance and causes significant voltage drop across this electrode. This may be an issue for larger area displays which in nature need a larger area common electrode.

[0010] Therefore, currently, the apertures of pixels for OLED displays are limited due to the necessity of drive transistors and other circuitry. Further, the aperture ratios of the OLEDs in OLED displays are also limited because of the necessity to have a minimal amount of space between OLEDs due to design rule requirements. Therefore, there is a need for increasing the aperture ratios of OLED based integrated circuit pixels for higher resolution displays.

SUMMARY

[0011] Aspects of the present disclosure include an integrated circuit for a color pixel, the circuit. The integrated circuit has a first organic light emitting device emitting light of a first color. A second organic light emitting device emits light of a second color. The second organic light emitting device is located under the first organic light emitting device. A third organic light emitting device emits light of a third color and is in alignment with the first organic light emitting device and above the second organic light emitting device.

[0012] Another example is a color display having a controller and an array of pixels coupled to the controller to display images. Each pixel includes a first organic light emitting device emitting light of a first color. Each pixel includes a second organic light emitting device emitting light of a second color. The second organic light emitting device is located in a bottom row under the first organic light emitting device. A third organic light emitting device emitting

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light of a third color is located in a top row with the first organic light emitting device. Corresponding first, second and third drive transistors are coupled to the first, second and third organic light emitting devices respectively.

[0013] Another example is an integrated circuit for a pixel. The integrated circuit includes a common electrode layer and an organic light emitting device located on the common electrode layer. The organic light emitting device includes an emission surface. A drive transistor is disposed on part of the emission surface. A reflector layer is disposed between the drive transistor and the organic light emitting device. The reflector layer includes an aperture over the emission surface and a reflective surface facing the emission surface. The reflective surface reflects light emitted from the light emitting surface through the aperture.

[0014] The foregoing and additional aspects and embodiments of the present invention will be apparent to those of ordinary skill in the art in view of the detailed description of various embodiments and/or aspects, which is made with reference to the drawings, a brief description of which is provided next.

BRIEF DESCRIPTION OF THE DRAWINGS

[0015] The foregoing and other advantages of the invention will become apparent upon reading the following detailed description and upon reference to the drawings.

[0016] FIG. 1A is a layout of a prior art integrated circuit for an OLED pixel;

[0017] FIG. 1B is a circuit diagram of one of the OLEDs and corresponding drive transistor for the OLED pixel in FIG. 1A;

[0018] FIG. 1C is a side view of the integrated circuit of the OLED pixel in FIG. 1A;

[0019] FIG. 2 is a block diagram of an AMOLED display with reference pixels to correct data for parameter compensation control;

[0020] FIG. 3 is a configuration of an integrated circuit for a RGB type pixel having staggered OLEDs for increased aperture;

[0021] FIG. 4 is a configuration of an integrated circuit for a RGBW type pixel having staggered OLEDs for increased aperture;

[0022] FIG. 5 is a configuration of an integrated circuit for a top emission arrangement for an RGB OLED pixel;

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[0023] FIG. 6 is an alternate configuration for an integrated circuit for a top emission RGB OLED pixel;

[0024] FIG. 7 is a cross section view of an OLED pixel with a reflector to increase luminance output from the pixel;

[0025] FIG. 8A is a graph of the aperture ratios of a known stripe arrangement of OLEDs in a pixel in comparison with the staggered arrangement in FIG. 3

[0026] FIG. 8B is a graph of the aperture ratio of known stripe arrangements of OLEDs in a pixel in comparison with a staggered top emission arrangement such as that in FIG. 7.

[0027] While the invention is susceptible to various modifications and alternative forms, specific embodiments have been shown by way of example in the drawings and will be described in detail herein. It should be understood, however, that the invention is not intended to be limited to the particular forms disclosed. Rather, the invention is to cover all modifications, equivalents, and alternatives falling within the spirit and scope of the invention as defined by the appended claims.

DETAILED DESCRIPTION

[0028] FIG. 2 is an electronic display system 200 having an active matrix area or pixel array 202 in which an array of active pixels 204a-d are arranged in a row and column configuration. Each of the active pixels 204 includes red, green and blue organic light emitting devices (OLED) to emit different color components that are combined to produce different colors for emission from the pixel. For ease of illustration, only two rows and columns of pixels are shown. External to the active matrix area 202 is a peripheral area 206 where peripheral circuitry for driving and controlling the pixel array 202 are located. The peripheral circuitry includes a gate or address driver circuit 208, a source or data driver circuit 210, a controller 212, and an optional supply voltage (e.g., Vdd) driver 214. The controller 212 controls the gate, source, and supply voltage drivers 208, 210, 214. The gate driver circuit 208, under control of the controller 212, operates on address or select lines SEL[i], SEL[i+1], and so forth, one for each row of pixels 204 in the pixel array 202. In pixel sharing configurations described below, the gate or address driver circuit 208 can also optionally operate on global select lines GSEL[j] and optionally /GSEL[j], which operate on multiple rows of pixels 204a-d in the pixel array 202,

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such as every two rows of pixels 204. The source driver circuit 210, under control of the controller 212, operates on voltage data lines Vdata[k], Vdata[k+1], and so forth, one for each column of pixels 204 in the pixel array 202. The voltage data lines carry voltage programming information to each pixel 204 indicative of brightness of each of the color components of the light emitting devices in the pixel 204. A storage element, such as a capacitor, in each of the light emitting devices of the pixels 204 stores the voltage programming information until an emission or driving cycle turns on each of the light emitting devices. The optional supply voltage driver 214, under control of the controller 212, controls a supply voltage (VDD) line, one for each row of pixels 204 in the pixel array 202.

[0029] The display system 200 may also include a current source circuit, which supplies a fixed current on current bias lines. In some configurations, a reference current can be supplied to the current source circuit. In such configurations, a current source control controls the timing of the application of a bias current on the current bias lines. In configurations in which the reference current is not supplied to the current source circuit, a current source address driver controls the timing of the application of a bias current on the current bias lines.

[0030] As is known, each pixel 204 in the display system 200 needs to be programmed with data indicating the brightness of each of the light emitting devices in the pixel 204 to produce the desired color to be emitted from the pixel 204. A frame defines the time period that includes a programming cycle or phase during which each and every pixel 204 in the display system 200 is programmed with programming voltages indicative of a brightness and a driving or emission cycle or phase during which each light emitting device in each pixel is turned on to emit light at a brightness commensurate with the programming voltage stored in a storage element. A frame is thus one of many still images that compose a complete moving picture displayed on the display system 200. There are at least two schemes for programming and driving the pixels: row-by-row, or frame-by-frame. In row-by-row programming, a row of pixels is programmed and then driven before the next row of pixels is programmed and driven. In frame-by-frame programming, all rows of pixels in the display system 200 are programmed first, and all of the pixels are driven row-by-row. Either scheme can employ a brief vertical blanking time at the beginning or end of each frame during which the pixels are neither programmed nor driven.

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[0031] The components located outside of the pixel array 202 may be located in a peripheral area 206 around the pixel array 202 on the same physical substrate on which the pixel array 202 is disposed. These components include the gate driver 208, the source driver 210 and the optional supply voltage control 214. Alternately, some of the components in the peripheral area can be disposed on the same substrate as the pixel array 202 while other components are disposed on a different substrate, or all of the components in the peripheral area can be disposed on a substrate different from the substrate on which the pixel array 202 is disposed. Together, the gate driver 208, the source driver 210, and the supply voltage control 214 make up a display driver circuit. The display driver circuit in some configurations may include the gate driver 208 and the source driver 210 but not the supply voltage control 214.

[0032] The display system 200 further includes a current supply and readout circuit 220, which reads output data from data output lines, VD [k], VD [k+1], and so forth, one for each column of pixels 204a, 204c in the pixel array 202. The drive transistors for the OLEDs in the pixels 204 in this example are thin film transistors that are fabricated from amorphous silicon. Alternatively, the drive transistors may be fabricated from polysilicon.

[0033] In the configurations for the OLEDs described below, the aperture ratio is improved through minimizing the blocked area of the OLED emission surface by changing the arrangement of the drive transistors and the OLEDs. Another configuration for top emission allows the light guided from the area that is blocked by the drive transistor and metallic layers such as power and programming lines to a window over the emission surface of the OLED. As a result, the aperture ratio is much larger than actual opening.

[0034] The arrangement of OLED and drive transistors described below makes the pixel opening less dependent to the fabrication design rules that require certain distances between OLEDs and certain widths of voltage supply and data lines. This technique allows fabrication of high resolution displays while results in reasonable aperture ratio without the need for a high resolution fabrication process. Consequently, the use of shadow masks becomes possible, or even easier, for partitioning the pixel for high pixel densities.

[0035] FIG. 3 shows a top view of an integrated circuit layout for a pixel 300 which is a staggered architecture for a RGB bottom emission pixel. The integrated circuit layout of the pixel 300 includes a top subrow 302 and a bottom subrow 304 each having a series of OLEDs.

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Each of the OLEDs constitute a sub-pixel in the individual pixels such as the pixel 300. The sub-pixels (e.g. green, red and blue) alternate between the subrows. In this example, the top subrow 302 includes a green OLED 310, a drive transistor 312, a red OLED 314 and a drive transistor 316. The bottom subrow 304 includes a drive transistor 320, a blue OLED 322, a drive transistor 324 and a green OLED 326. A select line 330 is fabricated on top of the top subrow 302 and a select line 332 is fabricated on the bottom of the bottom subrow 304. The drive transistor 316 and the green OLED 326 belong to a next pixel 350 in the array and share the select lines 330 and 332 with the pixel 300. The OLEDs 310, 314 and 322 in the pixel 300 are therefore in staggered arrangement allowing them to be placed closer together side by side. It is to be understood that the term subrow is simply used for convenience. From another perspective, the different OLEDs may be staggered on adjacent columns. The various OLEDs are arranged so certain OLEDs are next to each other and other OLEDs are above or below the OLEDs next to each other in order to allow the increase in the width of the OLEDs.

[0036] A power line 340 borders both the green OLED 310 and the drive transistor 320. A data line 342 is fabricated between the green OLED 310 and the drive transistor 312 of the top subrow 302 and continues between the drive transistor 320 and the blue OLED 322 of the bottom subrow 304. A power line 344 is fabricated between the drive transistor 312 and the red OLED 314 of the top subrow 302 and continues between the blue OLED 322 and the drive transistor 324 of the bottom subrow 304. The structure of the pixel 300 also includes a data line 346 fabricated between the red OLED 314 and the drive transistor 314 of the top subrow 302 and continues between the transistor 324 and the green OLED 326 of the bottom subrow 304. Another power line 348 borders the drive transistor 316 of the top subrow 302 and the green OLED 326 of the bottom subrow 304. The drive transistor 316 and the green OLED 326 are part of the next pixel 350 adjacent to the pixel 300 but share the data line 346.

[0037] In FIG. 3, the display circuit of the pixel 300 is divided into the two subrows 302 and 304. The OLEDs 310, 322 and 314 are put on top and bottom side of the pixel area alternatively. As a result, the distance between two adjacent OLEDs will be larger than the minimum required distance. Also, the data lines such as the data lines 342 and 346 may be shared between two adjacent pixels such as the pixel 300 and the adjacent pixel 350. This results in a large aperture ratio because the distance between the OLEDs such as the OLED 310 and the

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OLED 322 may be reduced due to the staggered configuration resulting in larger emission areas of the OLEDs. Since the OLEDs in the pixel 300 share power lines, the surface area necessary for such lines is reduced allowing the area to be open to the emission surfaces of the OLEDs therefore further increasing the aperture ratio.

[0038] FIG. 4 shows an example staggered architecture for a RGBW bottom emission display pixel circuit 400. The integrated circuit layout for the pixel 400 includes a top subrow 402 and a bottom subrow 404. In this example, the top subrow 402 includes a green OLED 410, a drive transistor 412, a red OLED 414 and a drive transistor 416. The bottom subrow 404 includes a drive transistor 420, a blue OLED 422, a drive transistor 424 and a white OLED 426. FIG. 4 shows the entire pixel which includes the four OLEDs 410, 414, 422 and 426.

[0039] A select line 430 is fabricated on top of the top subrow 402 and a select line 432 is fabricated on the bottom of the bottom subrow 404. A power line 440 borders both the green OLED 410 and the drive transistor 420. A data line 442 is fabricated between the green OLED 410 and the drive transistor 412 of the top subrow 402 and continues between the drive transistor 420 and the blue OLED 422 of the bottom subrow 404. A power line 444 is fabricated between the drive transistor 412 and the red OLED 414 of the top subrow 402 and continues between the blue OLED 422 and the drive transistor 424 of the bottom subrow 404. The circuit 400 also includes a data line 446 fabricated between the red OLED 414 and the drive transistor 416 of the top subrow 402 and continues between the drive transistor 424 and the white OLED 426 of the bottom subrow 404. Another power line 448 borders the drive transistor 416 of the top subrow 402 and the white OLED 426 of the bottom subrow 404. The power lines 440 and 448 are shared by adjacent pixels (not shown).

[0040] As with the configuration in FIG. 3, the pixel circuit 400 in FIG. 4 has increased aperture because the distance between parallel OLEDs may be decreased due to the staggered relationship between the OLEDs 410, 414, 422 and 426. The white OLED 426 is added since most of the display using the pixel circuit 400 typically emits white color and the white OLED 426 reduces continuous emissions from the blue OLED 422 which is primarily employed to emit white color in RGB type pixels such as the pixel 300 in FIG. 3. As with the configuration in FIG. 3, the distances between the OLEDs may be decreased resulting in greater exposure of the emission surface areas. Further, the sharing of the data and power supply lines also reduces the

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area necessary for such lines resulting in additional surface emission area being exposed for the OLEDs.

[0041] The same staggered arrangement as shown in FIGs. 3 and 4 may be used for the top emission type OLED integrated circuit. FIG. 5 shows a staggered color patterning for a RGB top-emission display structure 500. The structure 500 includes a top subrow 502 and a bottom subrow 504. The top subrow 502 includes a green OLED 512 and a red OLED 514. The drive transistors to drive the OLEDs 512 and 514 are mounted on a lower circuit layer 516 under the OLEDs 512 and 514. The bottom subrow 504 includes a blue OLED 522 and a green OLED 524. Drive transistors that drive the OLEDs 522 and 524 are fabricated on a circuit layer 526 under the OLEDs 522 and 524. In the display structure 500, the OLEDs 512, 514 and 522 make up one pixel, while the green OLED 524 is part of another pixel. Thus the structure 500 results in a display with interlocked pixels which share various data lines. Such pixels require some interpolation of image data since the data lines are shared between the OLEDs of the pixels.

[0042] A select line 530 is fabricated on top of the top subrow 502 and a select line 532 is fabricated on the bottom of the bottom subrow 504. A power line 540 borders both the green OLED 510 and the blue OLED 520. A data line 542 is fabricated under the green OLED 510 and of the top subrow 502 and continues under the blue OLED 522 of the bottom subrow 504. The data line 542 is used to program the green OLED 512 and the blue OLED 522. A power line 544 is fabricated between the green OLED 512 and the red OLED 514 of the top subrow 502 and continues between the blue OLED 522 and the green OLED 524 of the bottom subrow 504. A data line 546 fabricated over the red OLED 514 of the top subrow 502 and continues over the green OLED 524 of the bottom subrow 404. The data line 546 is used to program the red OLED 514 and the green OLED 524. Another power line 548 borders the red OLED 514 of the top subrow 502 and the green OLED 524 of the bottom subrow 504. The power lines 540 and 548 are shared by the transistors and OLEDs of adjacent pixels.

[0043] In this case, sharing the data programming lines 542 and 546 (VDATA) in the top emission structure 500 leads to more area for the drive transistors under the OLEDs. As a result, the drive transistors in the emission structure 500 may have larger source, drain and gate regions and the aging of the drive transistors will be slower because of lower current densities required by the transistors.

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[0044] The emission structure 500 allows reduction of distance between the OLEDs 512 and 522 because of the staggered arrangement. The OLEDs 512, 514, 522 and 524 may be made wider than a known OLED, but with a relatively shorter length. The wider OLED surface results in increased aperture ratio. The emission structure 500 requires a processed image data signal from a raw RGB signal because the OLEDs are staggered with OLEDs from the adjacent pixels. The transparent common electrode (not shown) over the OLEDs 512, 514, 522 and 524 has relatively lower resistance because of the wider areas of the OLEDs 512, 514, 522 and 524.

[0045] FIG. 6 shows an alternate pixel arrangement 600 for a top emission structure. The pixel arrangement 600 improves the aperture ratio and relaxes OLED manufacturing requirements. The pixel arrangement 600 includes different pixels 602, 604, 606 and 608. Each of the pixels has three OLEDs such as OLEDs 610, 612 and 614 which are disposed on a circuit layer 616 that includes the drive transistors to drive each of the OLEDs 610, 612 and 614. In this case, the OLED 610 emits green light and is in a row with the OLED 612 that emits red light. The OLED 614 emits a blue light and has a larger emission surface than the OLEDs 610 and 612. Select lines such as select lines 620, 622 and 624 run on the top and the bottom of the pixels 602, 604, 606 and 608. Power supply lines 630, 632 and 634 run along the sides of the pixels 602, 604, 606 and 608 to supply voltages for the OLEDs 610, 612 and 614 and their respective drive transistors. Data lines 640, 642, 644 and 646 run under the OLEDs of the pixels 602, 604, 606 and 608. For example, the data line 640 is used to program the OLED 610, the data line 642 is used to program the OLED 612 and either data line 640 or 644 is used to program the OLED 614 in the pixel 602.

[0046] In the structure 600, any single current is within one sub-row. As a result, the lines look straighter in a display composed of pixels using the arrangement 600 and so provide better quality for text application. The OLED 614 that emits blue light is larger than the OLEDs 610 and 612, covering substantially the entire width of the pixel 602, because the increased surface area for the blue color OLED 614 retards aging which is the result of inherent faster aging for a blue color OLED. The increased surface area requires lower current density to produce the same output as a smaller surface OLED and therefore ages slower. The structure 600 in FIG. 6 has an improved appearance over the structure 500 in FIG. 5 because the red, green and blue OLED elements are in a straight line as opposed to being staggered between

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pixels. As with the structure 500 in FIG. 5, the transparent common electrode (not shown) over the OLEDs 610, 612 and 614 has relatively lower resistance because of the wider areas of the OLEDs 610, 612 and 614.

[0047] FIG. 7 shows the cross section of a pixel structure 700 that is a modified bottom emission type pixel that increases aperture ratio by having a reflector focus light emitted from the areas of the emission area of an OLED 702 that are covered by other circuit components. The OLED 702 includes a cathode layer 704 and an anode layer 706. A common electrode layer 708 provides electrical bias to the other side of the OLED 702. The common electrode 708 can be shaped as a concave mirror to reflect more light toward the reflective surface 740. A drive transistor 710 is fabricated over part of the emission surface of the OLED 702. The drive transistor 710 includes a gate 712, a drain region 714 and a source region 716. The drive transistor 710 is fabricated on a clear substrate layer 720 that overlays the OLED 702. A metallization layer 730 is overlaid on the clear substrate 720 to form electrodes 732 and 734 contacting the drain region 714 and the source region 716 of the drive transistor 710 respectively and provide electrical connections to the other components of the circuit such as data and voltage supply lines. An electrode is also formed to the gate of the transistor 710 (not shown). The metallization layer 730 includes an aperture 736 through which light from the OLED 702 may be emitted through the clear substrate 720.

[0048] The pixel structure includes a reflector 740 that is disposed between the OLED 702 and the drive transistor 710. The reflector 740 includes a reflective surface 742 facing the emission surface of the OLED 702 that reflects light emitted from the OLED 702 that would be normally blocked by the drive transistor 710. The reflected light (shown in arrows in FIG. 7) is emitted out a window 744 in the reflector 740 to therefore increase the light actually emitted from the OLED 702.

[0049] Thus the OLED emission area is not limited to the opening window which is defined by the drive transistor and supporting components on the OLED 702. As a result, the OLED current density for a given luminance is lower than a conventional bottom emission arrangement. This arrangement including the reflector 740 requires lower OLED voltage and therefore lower power consumption to achieve the same luminance as a conventional OLED without the reflector. Moreover, the lifetime of the OLED 702 will be longer due to lower

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current density. This structure 700 may also be used with other techniques to further improve aperture ratio.

[0050] The aperture ratio for different display resolutions is demonstrated in a graph 800 in FIG. 8A. The graph 800 compares the aperture ratios of various configurations to display resolutions. One set of data points 802 shows the aperture ratios of a standard amorphous silicon red green blue pixel stripe structure as shown in FIG. 1A. A second set of data points 804 shows the aperture ratios of a standard polysilicon red green blue pixel stripe structure. As shown in FIG. 8A, the polysilicon based pixel has slightly better aperture ratios than the amorphous silicon based pixel. A third set of data points 806 shows the aperture ratios of a bottom emission staggered structure such as the structure of the pixel 300 shown in FIG. 3. As shown in the data points 802 in FIG. 8A, while the aperture ratio for higher resolution (e.g., 250 PPI) using a standard RGB stripe configuration is zero, the aperture ratio of the staggered pixel architecture in FIG. 3 in data points 806 is higher than 20% for up to 260 PPI.

[0051] FIG. 8B is a graph 850 showing the plots of aperture ratios at different display resolutions for various OLED pixel structures. One set of data points 852 shows the aperture ratios of a standard amorphous silicon red green blue pixel stripe structure as shown in FIG. 1A fabricated with a shadow mask. A second set of data points 854 shows the aperture ratios of an amorphous silicon bottom emission staggered structure such as the structure of the pixel 300 shown in FIG. 3 fabricated with a shadow mask. Another set of data points 856 shows the aperture ratios of a top emission type structure in a red green blue pixel strip structure fabricated by laser induced thermal imaging (LITI). A final set of data points 858 shows the aperture ratios of a top emission type structure using the staggered arrangement shown in FIG. 7 fabricated by LITI.

[0052] The aperture ratio is extracted for two types of OLED patterning (shadow mask with a 20- μ m gap and LITI with a 10- μ m gap) as shown in the data points 852 and 856 for a stripe type arrangement as shown in FIG. 1A. In the case of shadow mask fabrication, the aperture ratio for RGB stripe is limited by OLED design rules whereas a RGB stripe using LITI fabrication is limited by the TFT design rules. However, for both shadow mask and LITI fabrication, staggered color patterning can provide high resolution (e.g. 300 ppi) with large

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aperture ratio as shown by the data points 854 and 858. This resolution is provided without mandating tighter design rules as compared with conventional OLED layouts.

[0053] While particular embodiments and applications of the present invention have been illustrated and described, it is to be understood that the invention is not limited to the precise construction and compositions disclosed herein and that various modifications, changes, and variations can be apparent from the foregoing descriptions without departing from the spirit and scope of the invention as defined in the appended claims.

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WHAT IS CLAIMED IS:

1. An integrated circuit for a color pixel, the circuit comprising:
a first organic light emitting device emitting light of a first color;
a second organic light emitting device emitting light of a second color, the second organic light emitting device located under the first organic light emitting device; and
a third organic light emitting device emitting light of a third color in alignment with the first organic light emitting device and above the second organic light emitting device.
2. The integrated circuit of claim 1, further comprising:
a first drive transistor controlling the luminance of the first organic light emitting device located under the first organic light emitting device;
a second drive transistor next to the first light emitting device, the second drive transistor controlling the luminance of the second organic light emitting device; and
a third drive transistor controlling the luminance of the third organic light emitting device, the third drive transistor located next to the second organic light emitting device and under the third organic light emitting device.
3. The integrated circuit of claim 1, further comprising a voltage line coupled on one side of the first organic light emitting device, a data line coupled between the first organic light emitting device and the second organic light emitting device.
4. The integrated circuit of claim 2, further comprising a select line to activate the programming of the organic light emitting devices coupled to the first organic light emitting device, the second drive transistor and the third organic light emitting device.
5. The integrated circuit of claim 2, further comprising a fourth organic light emitting device located next to the third drive transistor and a fourth drive transistor controlling the luminance of the fourth organic light emitting device located next to the third organic light emitting device, wherein the fourth organic light emitting device emits white light.
6. The integrated circuit of claim 1, wherein the first color is green, the second color is blue and the third color is red.
7. The integrated circuit of claim 1, further comprising:

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a plurality of drive transistors being located under the first, second and third organic light emitting devices; and

a data line fabricated under the organic light emitting devices.

8. The integrated circuit of claim 7, wherein the first color is green, the second color is blue and the third color is red, wherein the second organic light emitting device has an emission area larger than the emission areas of the first and second light emitting devices.

9. The integrated circuit of claim 1, wherein the organic light emitting devices are fabricated using one of a shadow mask process or a laser induced thermal imaging process.

10. The integrated circuit of claim 1, further comprising a reflector layer disposed over at least one of the organic light emitting devices, the reflector layer having a reflective surface facing the organic light emitting device, and directing light from the organic light emitting device toward an aperture in the reflector layer.

11. A color display comprising:

a controller;

an array of pixels coupled to the controller to display images, wherein each pixel includes:

a first organic light emitting device emitting light of a first color;

a second organic light emitting device emitting light of a second color, the second organic light emitting device located in a bottom row under the first organic light emitting device;

a third organic light emitting device emitting light of a third color in a top row with the first organic light emitting device; and

corresponding first, second and third drive transistors coupled to the first, second and third organic light emitting devices respectively.

12. The color display of claim 1, wherein the organic light emitting devices are located on a substrate and the drive transistors are fabricated on the organic light emitting devices, the first drive transistor located on the bottom row under the first organic light emitting device, the second drive transistor located in the top row next to the first light emitting device, and the third drive transistor located on the bottom row next to the second organic light emitting device and under the third organic light emitting device.

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13. The color display of claim 12, wherein each pixel further includes a fourth organic light emitting device located next to the third drive transistor on the bottom row and a fourth drive transistor controlling the luminance of the fourth organic light emitting device located next to the third organic light emitting device on the top row, wherein the fourth organic light emitting device emits white light.

14. The color display of claim 12, wherein the first color is green, the second color is blue and the third color is red.

15. The color display of claim 12, further comprising:
a plurality of drive transistors being located under the first, second and third organic light emitting devices; and
a data line fabricated under the organic light emitting devices.

16. The color display of claim 15, wherein the first color is green, the second color is blue and the third color is red, wherein the second organic light emitting device has an emission area larger than the emission areas of the first and second light emitting devices.

17. An integrated circuit for a pixel, the integrated circuit comprising:
a common electrode layer;
an organic light emitting device located on the common electrode layer, the organic light emitting device including an emission surface;
a drive transistor disposed on part of the emission surface; and
a reflector layer disposed between the drive transistor and the organic light emitting device, the reflector layer including an aperture over the emission surface and a reflective surface facing the emission surface, the reflective surface reflecting light emitted from the light emitting surface through the aperture.

FIG. 1A (PRIOR ART)

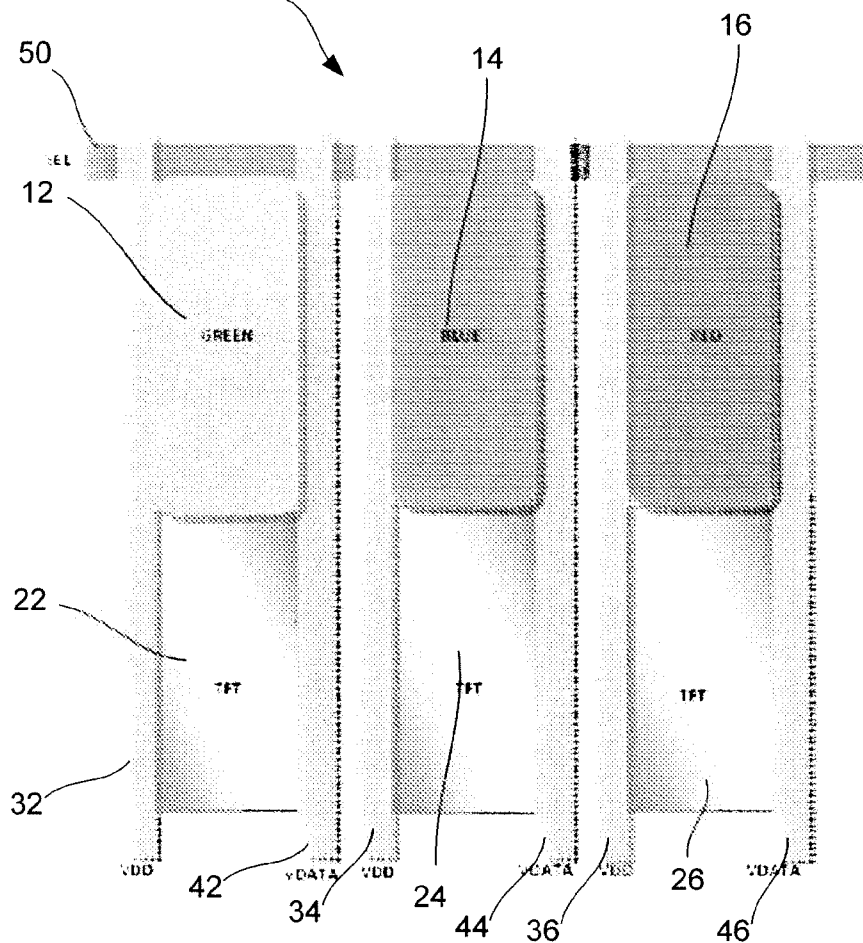


FIG. 1C (PRIOR ART)

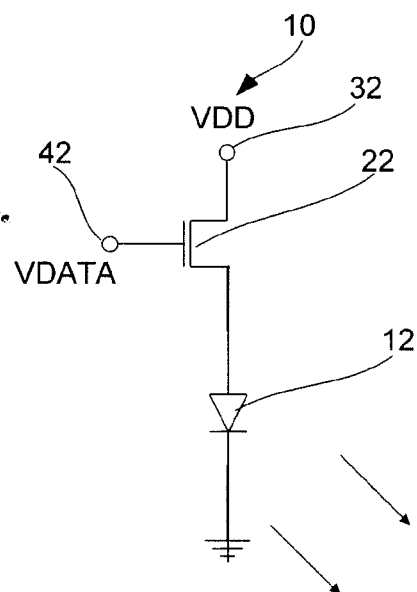


FIG. 1B (PRIOR ART)

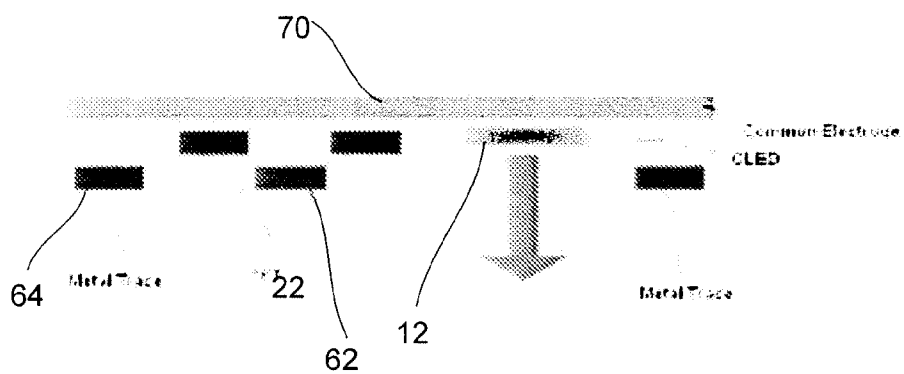


FIG. 2

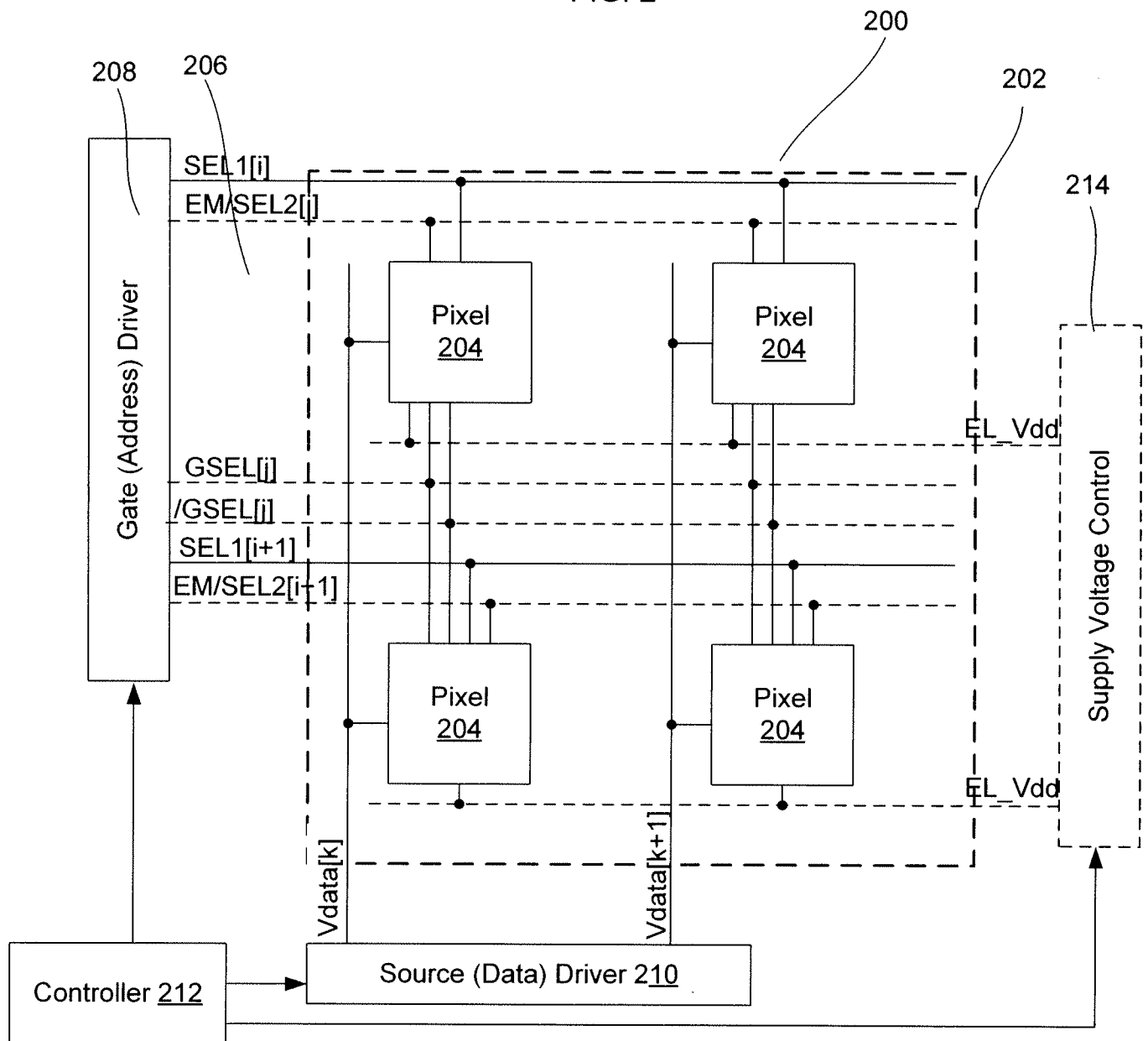


FIG. 3

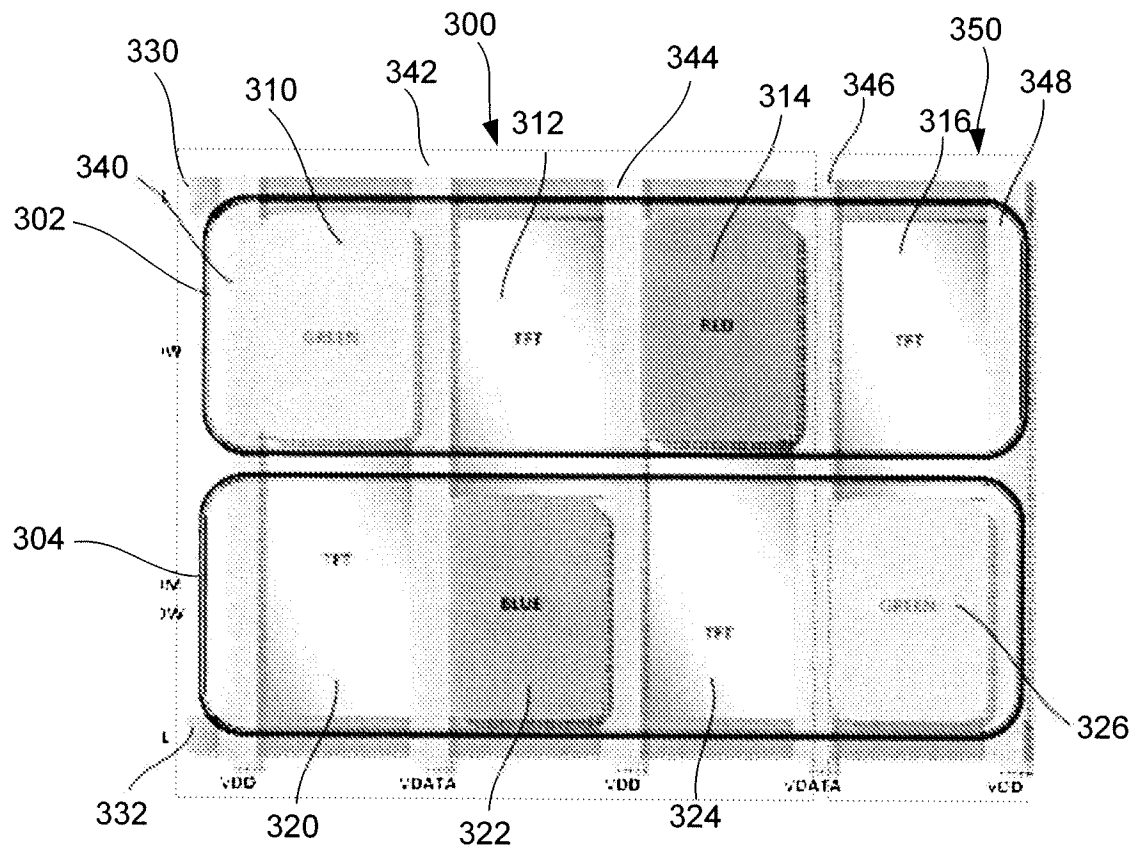


FIG. 4

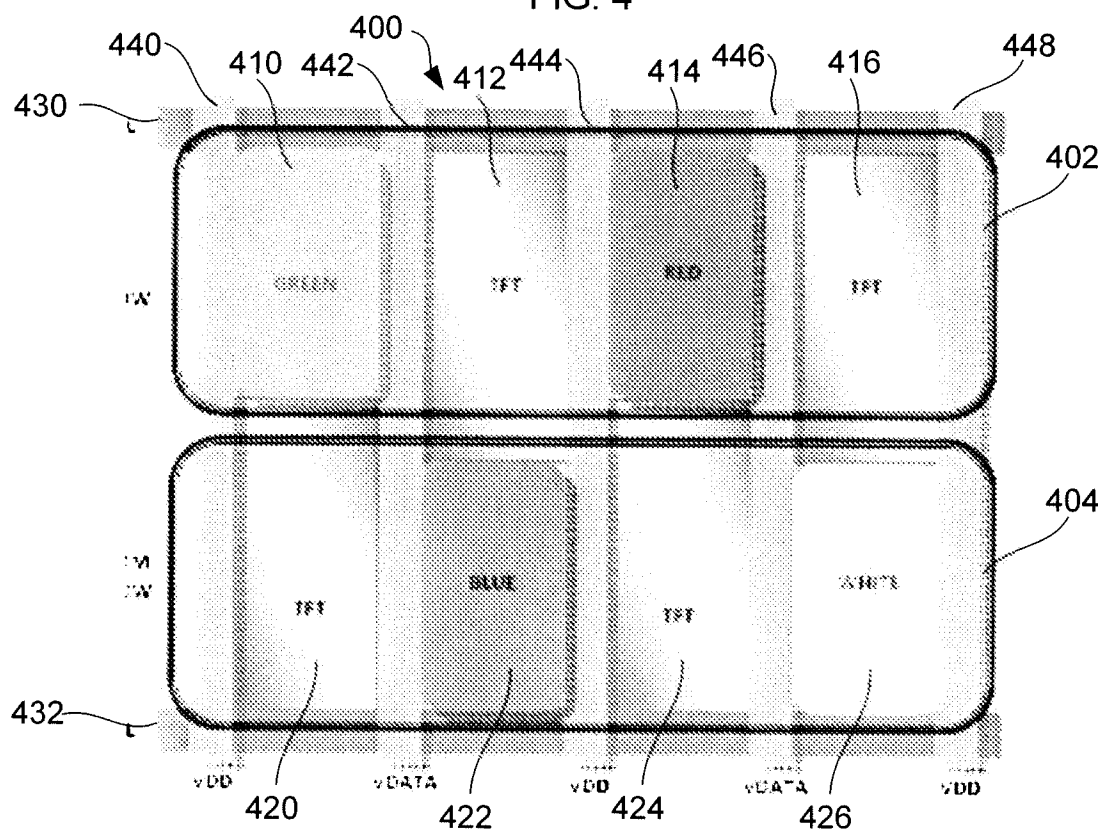


FIG. 5

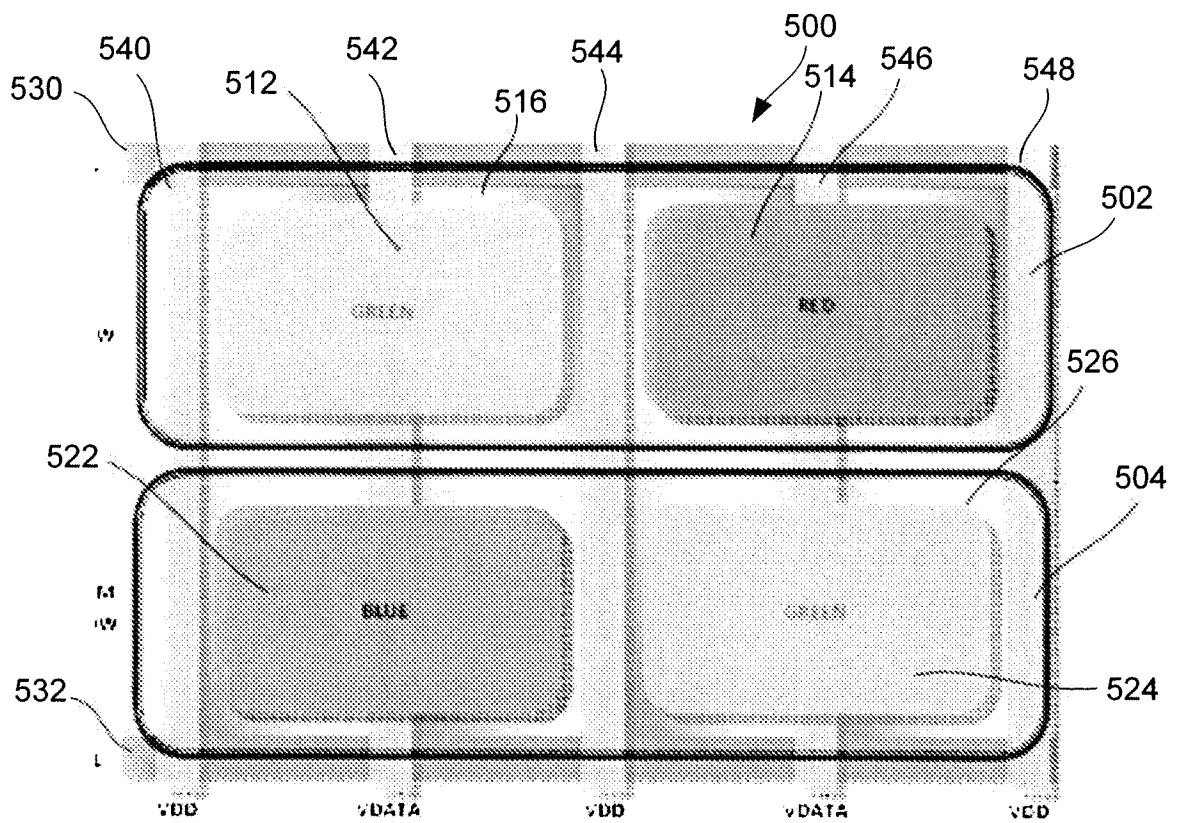


FIG. 6

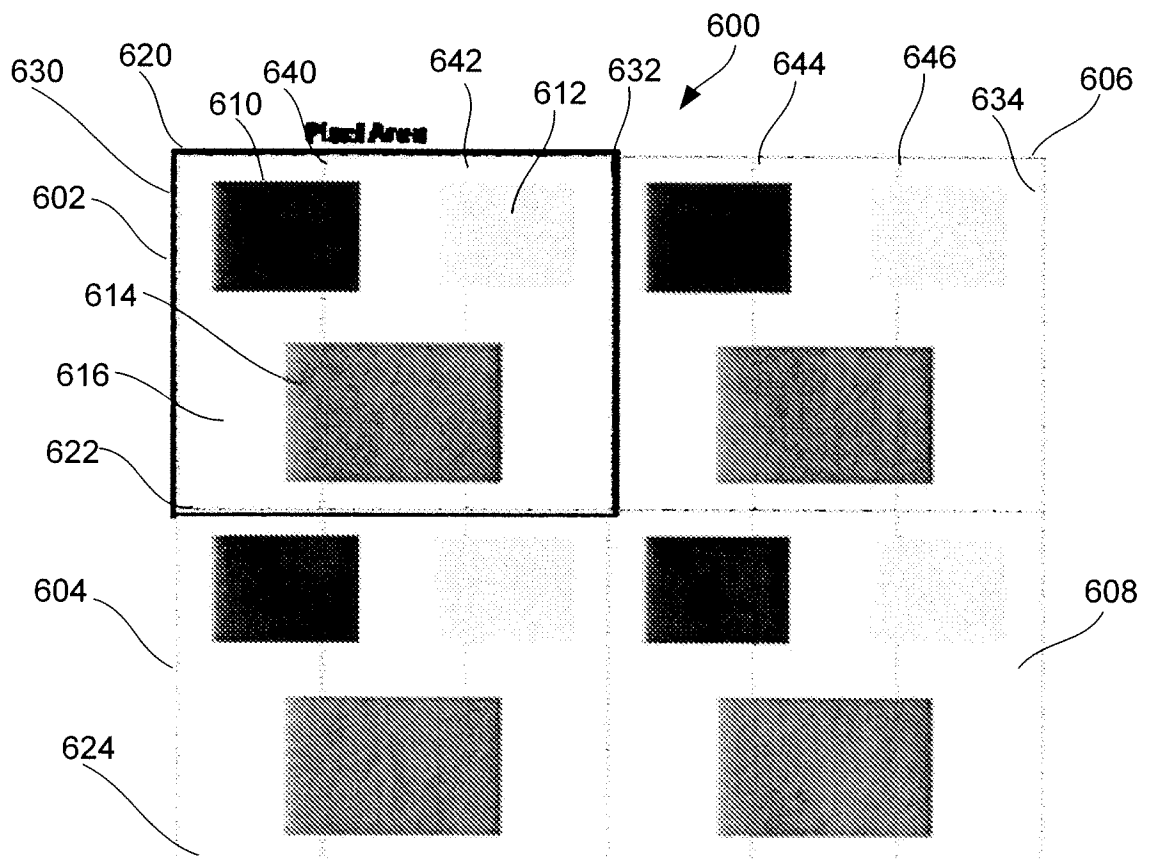


FIG. 7

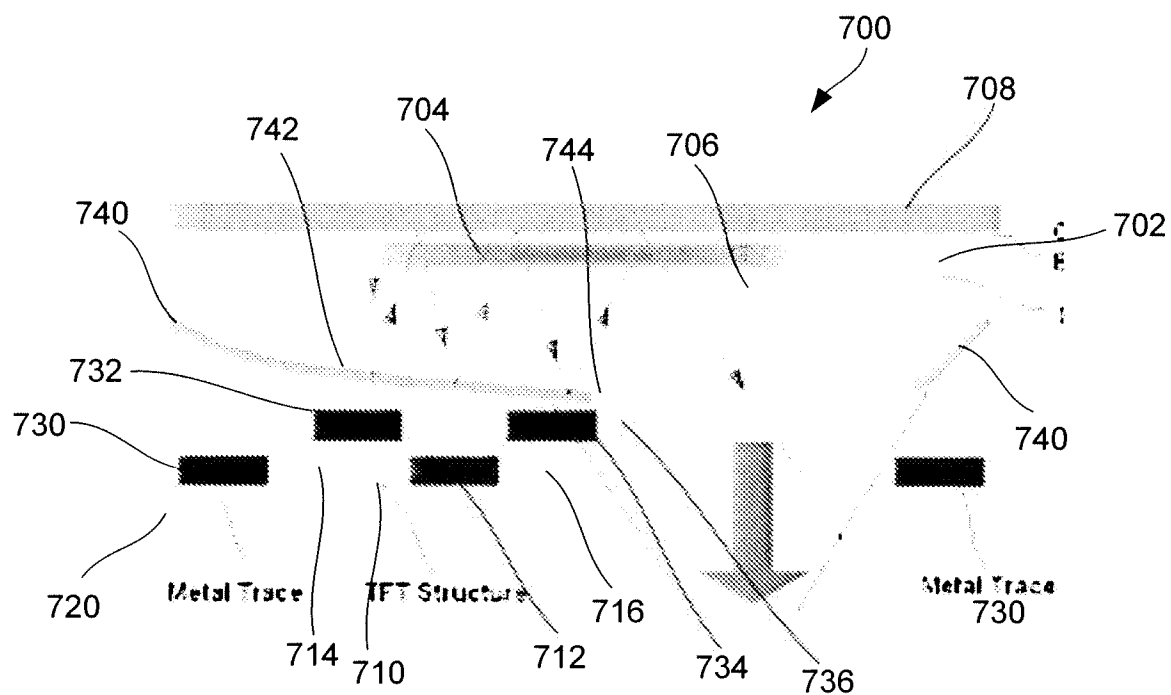


FIG. 8A

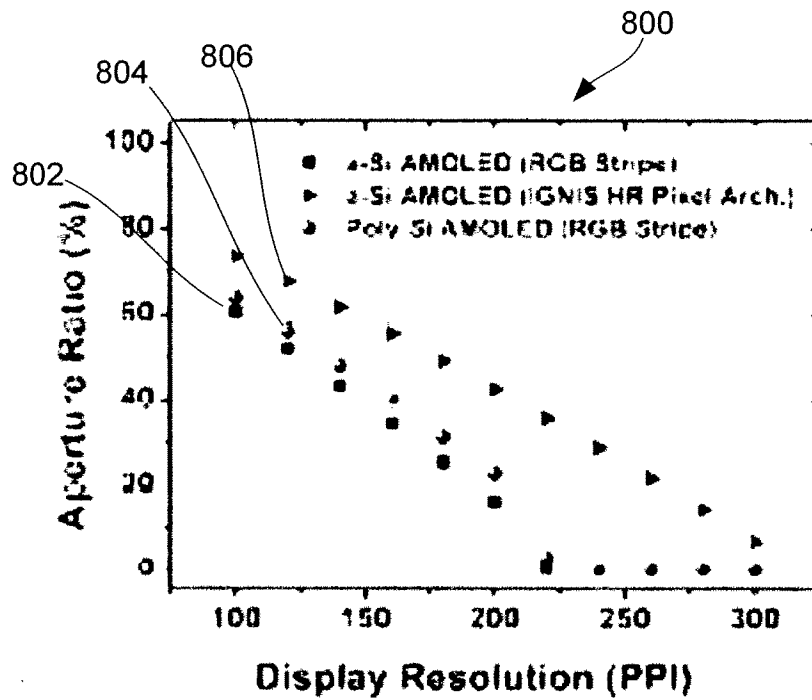
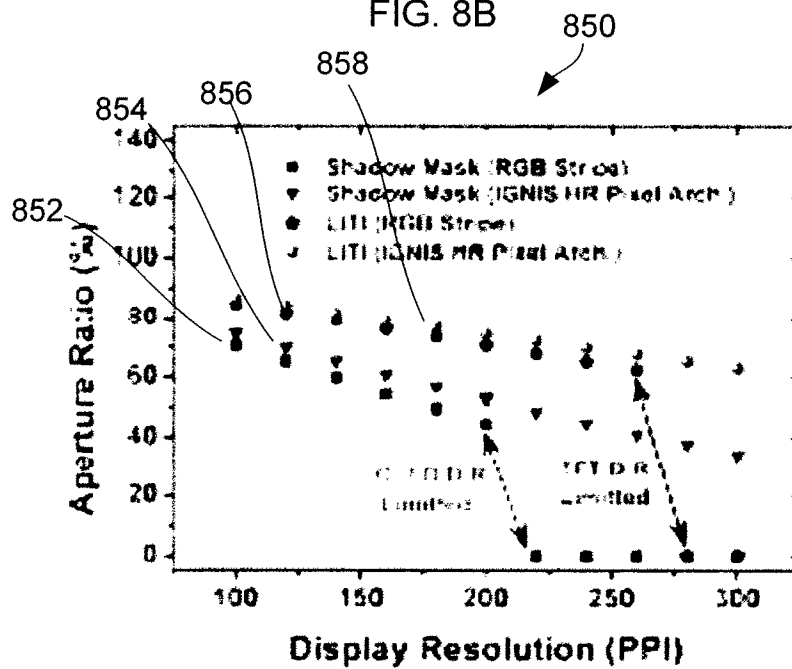


FIG. 8B



专利名称(译)	高分辨率像素架构		
公开(公告)号	EP2507837A2	公开(公告)日	2012-10-10
申请号	EP2010834297	申请日	2010-12-01
[标]申请(专利权)人(译)	伊格尼斯创新公司		
申请(专利权)人(译)	IGNIS创新INC.		
当前申请(专利权)人(译)	IGNIS创新INC.		
[标]发明人	CHAJI GHOLAMREZA GUPTA VASUDHA NATHAN AROKIA		
发明人	CHAJI, GHOLAMREZA GUPTA, VASUDHA NATHAN, AROKIA		
IPC分类号	H01L27/32 G09F9/33 G09G3/32 G09G3/3225		
CPC分类号	H01L27/3262 G09G3/3233 G09G2300/0426 G09G2300/0439 H01L27/3213 H01L27/326 H01L51/5271		
代理机构(译)	GRÜNECKER , KINKELDEY , STOCKMAIR & SCHWANHÄUSSER		
优先权	2686174 2009-12-01 CA		
其他公开文献	EP2507837A4		
外部链接	Espacenet		

摘要(译)

公开了一种使用交错布置的有机发光器件 (OLED) 以增加孔径比的高分辨率像素。该布置可以与底部和顶部发射型像素一起使用。该装置包括发射第一颜色光的第一有机发光装置。发射第二颜色光的第二有机发光装置位于第一有机发光装置下方的底行中。发射第三颜色光的第三有机发光装置与第一有机发光装置位于顶行。